# 74AUP1G74-Q100

Low-power D-type flip-flop with set and reset; positive-edge trigger

Rev. 4.1 — 9 August 2024

**Product data sheet** 

## 1. General description

The 74AUP1G74-Q100 is a single positive edge triggered D-type flip-flop with individual data (D), clock (CP), set ( $\overline{SD}$ ) and reset ( $\overline{RD}$ ) inputs, and complementary Q and  $\overline{Q}$  outputs. Data at the D-input that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition will be stored in the flip-flop and appear at the Q output.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device ensures very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 0.8 V to 3.6 V
- CMOS low power dissipation
- High noise immunity
- Overvoltage tolerant inputs to 3.6 V
- Low static power consumption; I<sub>CC</sub> = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3A exceeds 5000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V



# 3. Ordering information

**Table 1. Ordering information** 

Type number	Package	ckage								
	Temperature range Name Description									
74AUP1G74DC-Q100	-40 °C to +125 °C		plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1						

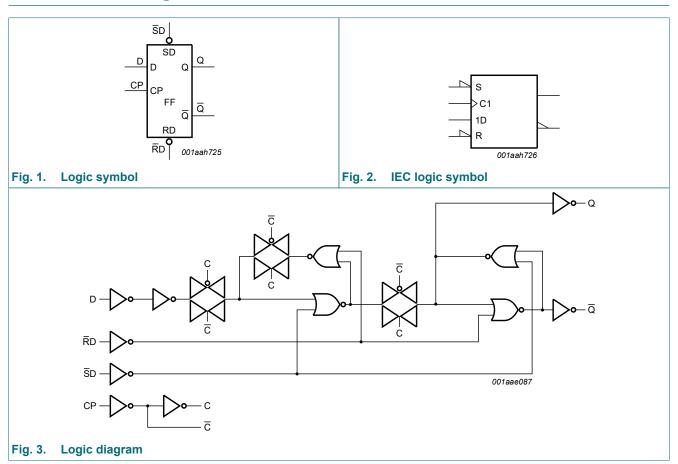
# 4. Marking

### Table 2. Marking codes

Type number	Marking code[1]
74AUP1G74DC-Q100	p74

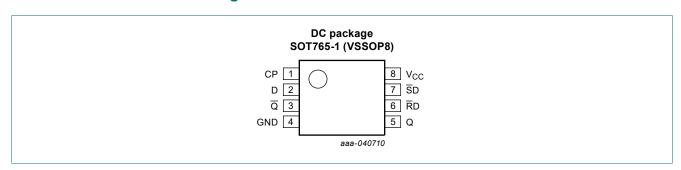
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram



# 6. Pinning information

### 6.1. Pinning



## 6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description			
СР	1	clock input			
D	2	data input			
Q	3	complement output			
GND	4	ground (0 V)			
Q	5	true output			
RD	6	asynchronous reset input (active LOW)			
SD	7	asynchronous set input (active LOW)			
V <sub>CC</sub>	8	supply voltage			

# 7. Functional description

#### Table 4. Function table for asynchronous operation

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

Input				Output		
SD RD		СР	D	Q	Q	
L	Н	X	Х	Н	L	
Н	L	Х	Х	L	Н	
L	L	X	Х	Н	Н	

### Table 5. Function table for synchronous operation

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ \uparrow = LOW - to - HIGH \ CP \ transition;$ 

 $\overline{Q}_{n+1}$ ,  $Q_{n+1}$  = state after the next LOW-to-HIGH CP transition.

Input		Output			
SD RD		СР	D	Q <sub>n+1</sub>	Q <sub>n+1</sub>
Н	Н	<b>↑</b>	L	L	Н
Н	Н	1	Н	Н	L

# 8. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+4.6	V
Vo	output voltage	Active mode and Power-down mode [1]	-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Io	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±20	mA
I <sub>CC</sub>	supply current		-	+50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C			
		SOT765-1 (VSSOP8) [2]	-	250	mW

<sup>[1]</sup> The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

**Table 7. Operating conditions** 

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; V <sub>CC</sub> = 0 V	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 0.8 V to 3.6 V	-	200	ns/V

## 10. Static characteristics

#### **Table 8. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 25	°C					
T <sub>amb</sub> = 25 °	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.70 × V <sub>CC</sub>	-	-	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$ $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$		-	V	
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V

<sup>[2]</sup> For SOT765-1 (VSSOP8) package: Ptot derates linearly with 4.9 mW/K above 99 °C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
V <sub>OL</sub>		$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 0.8 $V$ to 3.6 $V$	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.75 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.11	-	-	V
		$I_{O}$ = -1.9 mA; $V_{CC}$ = 1.65 V	1.32	-	-	V
		$I_{O}$ = -2.3 mA; $V_{CC}$ = 2.3 V	2.05	-	-	V
		$I_{O}$ = -3.1 mA; $V_{CC}$ = 2.3 V	1.9	-	-	V
		$I_{O}$ = -2.7 mA; $V_{CC}$ = 3.0 V	2.72	-	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 3.0 V	2.6	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>		$75 \times V_{CC}$ V 1.11 V 1.32 V 2.05 V 2.72 - V		
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3 × V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V
		$I_{O}$ = 2.3 mA; $V_{CC}$ = 2.3 V	-	-	0.31	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.31	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V
l <sub>l</sub>	input leakage current	$V_I$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V	-	-	±0.1	μΑ
l <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$	-	-	±0.2	μΑ
Δl <sub>OFF</sub>	additional power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	-	-	±0.2	μΑ
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.5	μΑ
ΔI <sub>CC</sub>	additional supply current	$V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ [1] $V_{CC} = 3.3 \text{ V}; \text{ per pin}$	-	-	40	μΑ
Cı	input capacitance	$V_{CC}$ = 0 V to 3.6 V; $V_I$ = GND or $V_{CC}$	-	0.6	-	pF
Co	output capacitance	V <sub>O</sub> = GND; V <sub>CC</sub> = 0 V	-	1.3	-	pF

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.70 × V <sub>CC</sub>	-	-	V
V <sub>IL</sub> VOH VOL VOL		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		input voltage $ \begin{array}{c c c c c c c c c c c c c c c c c c c $	-	V		
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
V <sub>ОН</sub>		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
$\begin{array}{c} V_{IL} \\ V_{CC} = 0.8 \ V \\ V_{CC} = 0.9 \ V \ to \ 1.95 \ V \\ V_{CC} = 2.3 \ V \ to \ 2.7 \ V \\ V_{CC} = 3.0 \ V \ to \ 3.6 \ V \\ V_{CC} = 3.0 \ V \ to \ 3.6 \ V \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \\ V_{CC} = 0.1 \ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \\ V_{CC} = 0.1 \ V_{CC} = 0.1 $						
		$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		$I_{O}$ = -1.1 mA; $V_{CC}$ = 1.1 V	$0.7 \times V_{CC}$	-	-	V
		$I_{O}$ = -1.7 mA; $V_{CC}$ = 1.4 V	1.03	-	-	V
		$I_{O}$ = -1.9 mA; $V_{CC}$ = 1.65 V	1.30	-	-	V
		$I_{O}$ = -2.3 mA; $V_{CC}$ = 2.3 V	1.97	-	-	V
		$I_O = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_{O}$ = -2.7 mA; $V_{CC}$ = 3.0 V	2.67	-	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.3 \times V_{CC}$	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.37	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.35	V
		$I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_{O}$ = 3.1 mA; $V_{CC}$ = 2.3 V	-	-	0.45	V
		$I_{O}$ = 2.7 mA; $V_{CC}$ = 3.0 V	-	-	0.33	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V	-	-	0.45	V
l <sub>l</sub>	input leakage current	$V_{I}$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V	-	-	±0.5	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.5	μA
ΔI <sub>OFF</sub>	additional power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.6	μΑ
I <sub>CC</sub>	supply current	$V_{I}$ = GND or $V_{CC}$ ; $I_{O}$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.9	μΑ
ΔI <sub>CC</sub>	additional supply current	$V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ [1] $V_{CC} = 3.3 \text{ V}; \text{ per pin}$	-	-	50	μΑ

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +125 °C					1
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.75 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.70 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.75 × V <sub>CC</sub>   -	V		
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.25 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
V <sub>ОН</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 0.8 $V$ to 3.6 $V$	V <sub>CC</sub> - 0.11	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.6 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	0.93	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.17	-	-	V
		$I_{O}$ = -2.3 mA; $V_{CC}$ = 2.3 V	1.77	-	-	V
		$I_{O}$ = -3.1 mA; $V_{CC}$ = 2.3 V	1.67	-	-	V
		$I_{O}$ = -2.7 mA; $V_{CC}$ = 3.0 V	2.40	-	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 3.0 V	2.30	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.11	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.33 × V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V
		$I_{O}$ = 2.3 mA; $V_{CC}$ = 2.3 V	-	-	0.36	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.50	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.50	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.75	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$	-	-	±0.75	μA
ΔI <sub>OFF</sub>	additional power-off leakage current	V <sub>1</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	$_{CC} = 3.0 \text{ V}$ 0.36 $_{CC} = 3.0 \text{ V}$ 0.50 $_{VCC} = 0 \text{ V to } 3.6 \text{ V}$ $\pm 0.75$ .6 V; $_{VCC} = 0 \text{ V}$ $\pm 0.75$ .6 V;		μΑ	
I <sub>CC</sub>	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	1.4	μΑ
Δl <sub>CC</sub>	additional supply current	$V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ [1] $V_{CC} = 3.3 \text{ V}; \text{ per pin}$	-	-	75	μΑ

<sup>[1]</sup> One input at  $V_{CC}$  - 0.6 V, other input at  $V_{CC}$  or GND.

# 11. Dynamic characteristics

### **Table 9. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 6.

Symbol	Parameter	Conditions	T	<sub>amb</sub> = 25	°C	T <sub>an</sub> -40 °C te	<sub>nb</sub> = o +85 °C	T <sub>ar</sub>	<sub>ոь</sub> = o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 5 p	F									
t <sub>pd</sub>		CP to Q, $\overline{Q}$ ; see Fig. 4. [2]								
	delay	V <sub>CC</sub> = 0.8 V	-	25.4	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.9	6.7	14.0	2.6	14.2	2.6	14.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.4	4.5	7.6	2.3	8.3	2.3	8.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	3.5	5.7	1.7	6.5	1.7	6.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	2.6	3.8	1.4	4.4	1.4	4.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	2.2	3.1	1.2	3.4	1.2	3.7	ns
		$\overline{SD}$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ . [2]								
		V <sub>CC</sub> = 0.8 V	-	19.6	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.7	5.6	11.0	2.5	11.4	2.5	11.5	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.4	4.0	6.3	2.2	6.9	2.2	7.3	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.0	3.3	4.9	1.7	5.6	1.7	5.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.9	2.7	3.7	1.7	4.0	1.7	4.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	2.5	3.2	1.5	3.6	1.5	3.8	ns
		$\overline{R}D$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ . [2]								
		V <sub>CC</sub> = 0.8 V	-	19.2	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.6	5.5	11.0	2.5	11.3	2.5	11.5	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.3	3.9	6.3	2.2	6.8	2.2	7.3	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	3.2	5.0	1.8	5.6	1.8	5.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.9	2.6	3.6	1.7	4.1	1.7	4.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	2.4	3.3	1.5	3.6	1.5	3.8	ns
f <sub>max</sub>	maximum	CP; see Fig. 4.								
	frequency	V <sub>CC</sub> = 0.8 V	-	53	-	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	203	-	170	-	170	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	347	-	310	-	300	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	435	-	400	-	390	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	550	-	490	-	480	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	619	-	550	-	510	-	MHz

Symbol	Parameter	Conditions		T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C		T <sub>amb</sub> = -40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 10	pF								<u> </u>		
t <sub>pd</sub>		CP to Q, Q; see Fig. 4.	[2]								
	delay	V <sub>CC</sub> = 0.8 V		-	28.9	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		3.1	7.5	15.8	2.9	16.1	2.9	16.1	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		2.7	5.1	8.7	2.4	9.4	2.4	9.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.5	4.1	6.5	2.2	7.2	2.2	7.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.0	3.2	4.6	1.8	5.3	1.8	5.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.8	2.8	3.8	1.6	4.1	1.6	4.4	ns
		SD to Q, Q; see Fig. 5.	[2]								
		V <sub>CC</sub> = 0.8 V		-	23.2	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		2.9	6.5	12.9	2.8	13.3	2.8	13.5	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		2.7	4.6	7.5	2.3	7.9	2.3	8.3	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.6	3.9	5.6	2.3	6.3	2.3	6.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.3	3.2	4.4	2.0	4.8	2.0	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.2	3.0	3.9	1.9	4.2	1.9	4.4	ns
		$\overline{R}D$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ .	[2]								
		V <sub>CC</sub> = 0.8 V		-	22.7	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		2.8	6.4	12.8	2.7	13.2	2.7	13.4	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		2.6	4.5	7.5	2.3	8.1	2.3	8.4	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.5	3.3	5.8	2.3	6.3	2.3	6.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.2	3.2	4.4	2.0	4.9	2.0	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.0	2.9	4.0	1.9	4.3	1.9	4.5	ns
f <sub>max</sub> maximum frequency	CP; see Fig. 4.										
	frequency	V <sub>CC</sub> = 0.8 V		-	52	-	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V		-	192	-	150	-	150	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V		-	324	-	280	-	230	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V		-	421	-	310	-	250	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V		-	486	-	370	-	360	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V		-	550	-	410	-	360	-	MHz

**Product data sheet** 

Symbol	Parameter	Conditions		T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C		T <sub>amb</sub> = -40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 15	pF								'		
t <sub>pd</sub>		CP to Q, Q; see Fig. 4.	[2]								
	delay	V <sub>CC</sub> = 0.8 V		-	32.4	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		3.5	8.3	17.6	3.3	17.8	3.3	18.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		3.2	5.6	9.5	2.8	10.5	2.8	11.1	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.7	4.6	7.2	2.5	8.1	2.5	8.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.4	3.6	5.2	2.2	5.8	2.2	6.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.2	3.2	4.4	2.0	4.9	2.0	5.2	ns
		SD to Q, Q; see Fig. 5.	[2]								
		V <sub>CC</sub> = 0.8 V		-	26.7	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		3.3	7.3	14.7	3.1	15.2	3.1	15.4	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		3.2	5.2	8.3	2.9	9.0	2.9	9.5	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.8	4.3	6.4	2.5	7.1	2.5	7.5	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.8	3.7	5.1	2.2	5.5	2.2	5.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.5	3.5	4.6	2.4	5.0	2.4	5.2	ns
		$\overline{RD}$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ .	[2]								
		V <sub>CC</sub> = 0.8 V		-	26.1	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V		3.2	7.2	14.5	3.1	15.0	3.1	15.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V		3.1	5.1	8.4	2.7	9.2	2.7	9.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.7	4.3	6.5	2.6	7.3	2.6	7.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.6	3.6	5.0	2.4	5.5	2.4	5.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.4	3.4	4.6	2.3	5.0	2.3	5.2	ns
f <sub>max</sub> maximum frequency	CP; see Fig. 4.										
	frequency	V <sub>CC</sub> = 0.8 V		-	50	-	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V		-	181	-	120	-	120	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V		-	301	-	190	-	160	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V		-	407	-	240	-	190	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V		-	422	-	300	-	270	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V		-	481	-	320	-	300	-	MHz

Symbol	Parameter	Conditions	T,	<sub>amb</sub> = 25	°C	T <sub>amb</sub> = -40 °C to +85 °C		T <sub>amb</sub> = -40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 30	pF							<u> </u>	-	
t <sub>pd</sub>	propagation	CP to Q, $\overline{Q}$ ; see Fig. 4. [2]								
	delay	V <sub>CC</sub> = 0.8 V	-	42.7	-	_	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.2	10.6	22.5	4.0	23.0	4.0	23.3	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.7	7.2	12.0	3.7	13.3	3.7	14.0	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.5	5.8	9.2	3.4	10.4	3.4	11.0	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.3	4.7	6.6	3.0	7.3	3.0	7.8	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.0	4.3	5.8	2.8	6.8	2.8	7.3	ns
		$\overline{SD}$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ . [2]								
		V <sub>CC</sub> = 0.8 V	-	37.0	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.0	9.5	19.8	3.8	20.8	3.8	21.1	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.8	6.7	10.9	3.7	12.0	3.7	12.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.7	5.6	8.4	3.5	9.3	3.5	9.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.7	4.8	6.6	3.2	7.2	3.2	7.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.4	4.6	6.0	3.1	6.8	3.1	7.1	ns
		$\overline{RD}$ to Q, $\overline{Q}$ ; see $\underline{Fig. 5}$ . [2]								
		V <sub>CC</sub> = 0.8 V	-	36.4	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.9	9.4	19.5	3.8	20.2	3.8	20.5	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.6	6.6	10.9	3.7	12.0	3.7	12.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.5	5.5	8.5	3.5	9.5	3.5	10.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.5	4.7	6.5	3.2	7.1	3.2	7.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.3	4.4	6.1	3.1	7.1	3.1	7.5	ns
f <sub>max</sub>	maximum	CP; see Fig. 4.								
	frequency	V <sub>CC</sub> = 0.8 V	-	28	-	-	-	-	-	MHz
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	145	-	70	-	70	-	MHz
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	185	-	120	-	110	-	MHz
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	270	-	150	-	120	-	MHz
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	290	-	190	-	170	-	MHz
1		V <sub>CC</sub> = 3.0 V to 3.6 V	-	315	-	200	-	190	-	MHz

Symbol	Parameter	Conditions	T,	<sub>amb</sub> = 25	°C	T <sub>amb</sub> = -40 °C to +85 °C		T <sub>amb</sub> = -40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 5 p	F, 10 pF, 15 p	F and 30 pF			'					
t <sub>su</sub>	set-up time	D to CP HIGH; see Fig. 4.								
		V <sub>CC</sub> = 0.8 V	-	3.4	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	0.6	-	1.2	-	1.2	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	0.3	-	0.6	-	0.6	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	0.4	-	0.5	-	0.5	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.2	-	0.4	-	0.4	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.3	-	0.4	-	0.4	-	ns
		D to CP LOW; see Fig. 4.								
		V <sub>CC</sub> = 0.8 V	-	3.0	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	0.5	-	1.2	-	1.2	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	0.3	-	0.7	-	0.7	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	0.4	-	0.7	-	0.7	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.5	-	0.7	-	0.7	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.6	-	0.8	-	0.8	-	ns
t <sub>h</sub>	hold time	D to CP; see Fig. 4.								
		V <sub>CC</sub> = 0.8 V	-	-1.9	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	-0.3	-	0.5	-	0.5	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	-0.2	-	0.2	-	0.2	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-0.2	-	0.1	-	0.1	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-0.2	-	0.1	-	0.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-0.2	-	0.1	-	0.1	-	ns
t <sub>rec</sub>	recovery	RD; see Fig. 5								
	time	V <sub>CC</sub> = 1.1 V to 1.3 V	-	-0.5	-	-0.9	-	-0.9	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	-0.2	-	-0.6	-	-0.6	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-0.2	-	-0.4	-	-0.4	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-0.1	-	-0.1	-	-0.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-0.1	-	-0.1	-	-0.1	-	ns
		SD; see Fig. 5.								
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	-0.5	-	-0.3	-	-0.3	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	-0.4	-	-0.1	-	-0.1	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-0.3	-	0	-	0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-0.2	-	0.1	-	0.1	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-0.1	_	0.1	-	0.1	-	ns

Symbol	Parameter	Conditions	T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C		T <sub>amb</sub> = -40 °C to +125 °C		Unit
		Min	Typ[1]	Max	Min	Max	Min	Max		
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Fig. 4.								
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	2.1	-	2.7	-	2.7	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	1.1	-	1.5	-	1.5	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	0.9	-	1.6	-	1.6	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	0.6	-	1.7	-	1.7	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	0.6	-	1.9	-	1.9	-	ns
		SD or RD LOW; see Fig. 5.								
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	4.2	-	11.3	-	11.5	-	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	2.3	-	6.2	-	6.4	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	1.8	-	4.8	-	5.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	1.2	-	3.3	-	3.5	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	1.1	-	2.6	-	2.8	-	ns
C <sub>PD</sub>	power dissipation	$f_i$ = 1 MHz; [3] $V_I$ = GND to $V_{CC}$								
	capacitance	V <sub>CC</sub> = 0.8 V	-	2.8	-	-	-	-	-	pF
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	2.9	-	-	-	-	-	pF
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	3.0	-	-	-	-	-	pF
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	3.0	-	-	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	3.5	-	-	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	3.9	-	-	-	-	-	pF

All typical values are measured at nominal V<sub>CC</sub>.

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

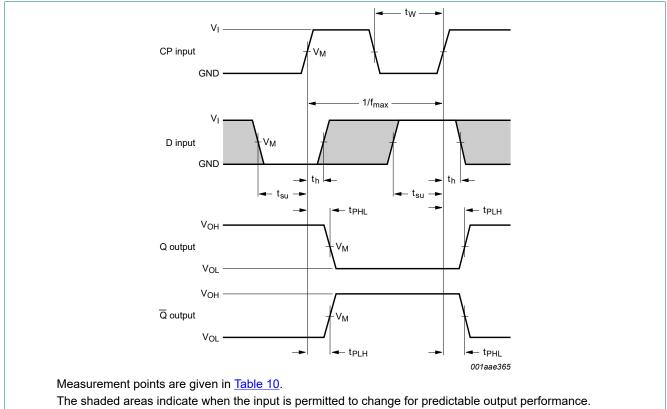
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

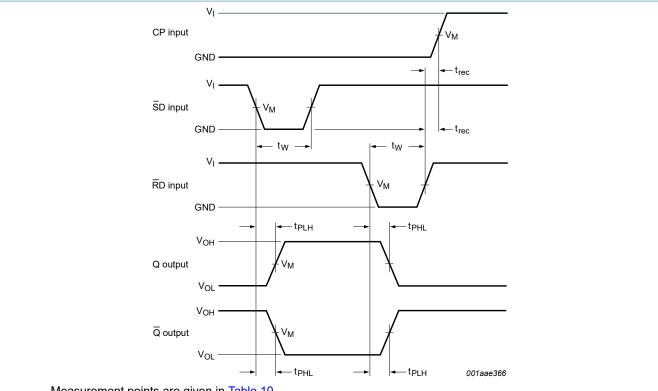
 $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

### 11.1. Waveforms and test circuit



V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 4. The clock input (CP) to output  $(Q, \overline{Q})$  propagation delays, the data input (D) to clock input (CP) set-up and hold times and the clock input (CP) pulse width and maximum frequency



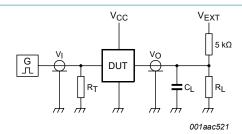
Measurement points are given in Table 10.

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 5. The set input ( $\overline{SD}$ ) and reset input ( $\overline{RD}$ ) to output ( $\overline{Q}$ ,  $\overline{Q}$ ) propagation delays, the set input ( $\overline{SD}$ ) and reset input (RD) pulse widths and the reset input (RD) to clock input (CP) recovery time

**Table 10. Measurement points** 

Supply voltage	Output	Input		
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	VI	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 3.0 ns



Test data is given in Table 11.

Definitions for test circuit:

R<sub>L</sub> = Load resistance;

C<sub>L</sub> = Load capacitance including jig and probe capacitance;

R<sub>T</sub> = Termination resistance should be equal to the output impedance Zo of the pulse generator;

V<sub>EXT</sub> = External voltage for measuring switching times.

#### Fig. 6. Test circuit for measuring switching times

#### Table 11. Test data

Supply voltage	Load		V <sub>EXT</sub>			
V <sub>CC</sub>	C <sub>L</sub>	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V <sub>CC</sub>	

[1] For measuring enable and disable times  $R_L$  = 5 k $\Omega$ . For measuring propagation delays, setup and hold times and pulse width  $R_L$  = 1 M $\Omega$ .

# 12. Package outline

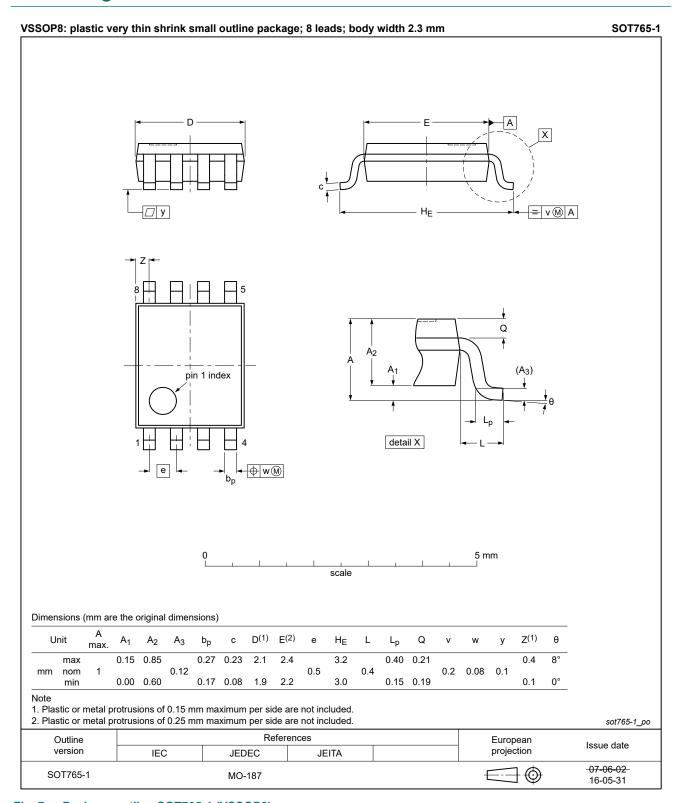


Fig. 7. Package outline SOT765-1 (VSSOP8)

# 13. Abbreviations

#### **Table 12. Abbreviations**

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council

# 14. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74AUP1G74_Q100 v.4.1	20240809	Product data sheet	-	74AUP1G74_Q100 v.3				
74AUP1G74_Q100 v.4	20230714	Product data sheet	-	74AUP1G74_Q100 v.3				
Modifications:	Section 2 updated.: ESD specification updated according to the latest JEDEC standard.							
74AUP1G74_Q100 v.3	20220620	Product data sheet	-	74AUP1G74_Q100 v.2				
Modifications:	<ul> <li><u>Section 1</u> and <u>Section 2</u> updated.</li> <li><u>Table 6</u>: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> </ul>							
74AUP1G74_Q100 v.2	20170410	Product data sheet	-	74AUP1G74_Q100 v.1				
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>							
74AUP1G74_Q100 v.1	20150527	Product data sheet	-	-				

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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